

Film Capacitors

Metallized Polyester Film Capacitors (MKT)

Series/Type: B32572, B32573

Date: May 2009

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Metallized polyester film capacitors (MKT)

B32572, B32573

Ignition (stacked) SilverCap™

Typical applications

- Ignition for gas, engines, generators
- Energy storage

Climatic

- Max. operating temperature: 125 °C
- Climatic category (IEC 60068-1): 55/125/56

Features

- Special dimensions available on request
- High pulse strength

Construction

- Dielectric: polyethylene terephthalate (polyester, PET)
- Stacked-film technology
- Uncoated

Terminals

■ Parallel wire leads, lead-free tinned

Marking

Rated capacitance (coded), rated DC voltage

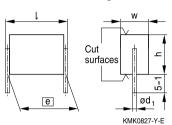
Delivery mode

Bulk (untaped)

Notes on mounting

When mounting these capacitors, take into account creepage distances and clearances to adjacent live parts. The insulating strength of the cut surfaces to other live parts of the circuit is 1.5 times the capacitors rated DC voltage, but is always at least 300 V DC.

Dimensional drawing



Dimensions in mm

| Lead spacing | Lead diameter | Type |
|---------------|----------------|--------|
| <i>e</i> ±0.4 | d ₁ | 1,700 |
| 15.0 | 0.8 | B32572 |
| 22.5 | 0.8 | B32573 |





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Overview of available types

| Lead spacing | 15.0 mm | 22.5 mm |
|--|---------|---------|
| Туре | B32572 | B32573 |
| Page | 4 | 5 |
| V _R (V DC) V _{RMS} (V AC) | 250 | 250 |
| V _{RMS} (V AC) | 160 | 160 |
| C _R (μF) | | |
| 0.68 | | |
| 1.0 | | |
| 1.5 | | |
| 2.2 | | |





B32572

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Ordering codes and packing units (lead spacing 15 mm)

| V _R | V_{RMS} | C _R | Max. dimensions | Ordering code | Untaped |
|----------------|-----------|----------------|-------------------------------|------------------|----------|
| | f ≤60 Hz | | $w \times h \times l$ | (composition see | |
| V DC | V AC | μF | mm | below) | pcs./MOQ |
| 250 | 160 | 0.68 | $7.0 \times 11.0 \times 16.5$ | B32572A3684+000 | 1800 |
| | | 1.0 | $9.1\times11.7\times16.5$ | B32572A3105+000 | 1200 |
| | | 1.5 | $11.5\times13.5\times16.5$ | B32572A3155+000 | 800 |
| | | 2.2 | $11.5\times19.8\times16.5$ | B32572A3225+000 | 600 |

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further E series and intermediate capacitance values on request.

Special dimensions available on request.

For corresponding design rules, refer to chapter "General technical information", page .

Composition of ordering code

+ = Capacitance tolerance code:

 $M = \pm 20\%$

 $K = \pm 10\%$

 $J = \pm 5\%$







Ordering codes and packing units (lead spacing 22.5 mm)

| V_R | V_{RMS} | C _R | Max. dimensions | Ordering code | Untaped |
|-------|-----------|----------------|---------------------------|------------------|----------|
| | f ≤60 Hz | | $w \times h \times l$ | (composition see | |
| V DC | V AC | μF | mm | below) | pcs./MOQ |
| 250 | 160 | 0.68 | 5.6 × 9.2 × 24.0 | B32573A3684+000 | 4720 |
| | | 1.0 | $6.4\times11.8\times24.0$ | B32573A3105+000 | 4200 |
| | | 1.5 | $7.6\times14.3\times24.0$ | B32573A3155+000 | 3720 |
| | | 2.2 | $8.9\times17.4\times24.0$ | B32573A3225+000 | 2240 |

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further E series and intermediate capacitance values on request.

Special dimensions available on request.

For corresponding design rules, refer to chapter "General technical information", page .

Composition of ordering code

+ = Capacitance tolerance code:

 $M = \pm 20\%$

 $K = \pm 10\%$

 $J = \pm 5\%$





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Technical data

| Operating temperature range | Max. opera | ting temperature T _{op,max} | +125 °C |
|---|---|---|--|
| | Upper category temperature T _{max} | | +125 °C |
| | Lower category temperature T _{min} | | −55 °C |
| | Rated temp | | +85 °C |
| Dissipation factor tan δ (in 10-3) | at | C _R ≤1 μF | C _R > 1 μF |
| at 20 °C | 1 kHz | 8 | 10 |
| (upper limit values) | 10 kHz | 15 | _ |
| Time constant $\tau = C_R \cdot R_{ins}$ | 2500 s | | |
| at 20 °C, rel. humidity ≤ 65% | | | |
| (minimum as-delivered values) | | | |
| DC test voltage | 1.6 · V _R , 2 s | 3 | |
| Category voltage V _C | T _A (°C) | DC voltage derating | AC voltage derating |
| (continuous operation with $\ensuremath{V_{\text{DC}}}$ | $T_A \le 85$ | $V_C = V_R$ | $V_{C,RMS} = V_{RMS}$ |
| or V_{AC} at $f \le 60 \text{ Hz}$) | 85 <t<sub>A≤125</t<sub> | $V_{\rm C} = V_{\rm R} \cdot (165 - T_{\rm A})/80$ | $V_{C,RMS} = V_{RMS} \cdot (165 - T_A)/80$ |
| Max. charging voltage C _{ch} | $1.2 \cdot V_R$ for | ≤1s | |
| Damp heat test | 56 days1)/40 °C/93% relative humidity | | 1 |
| Limit values after damp | Capacitance change ∆C/C | | ≤ 5% |
| heat test | Dissipation factor change Δ tan δ | | ≤ 3 · 10 ⁻³ (at 1 kHz) |
| | | | ≤ 5 · 10 ⁻³ (at 10 kHz) |
| | Time consta | ant $\tau = C_R \cdot R_{ins}$ | ≥ 50% of minimum |
| | | | as-delivered values |
| Reliability: | | | |
| Failure rate λ | 1 fit (≤ 2 · 1 | 0 ⁻⁹ /h) at 0.5 · V _R , 40 °C | |
| Service life t _{SL} | 200 000 h a | at 1.0 ⋅ V _R , 85 °C | |
| | For conversion to other operating conditions and temperatures, refer to chapter "Quality, 2 Reliability". | | • |
| Failure criteria: | | , | |
| Total failure | Short circuit or open circuit | | |
| Failure due to variation | | e change ∆C/C | > 10% |
| of parameters | Dissipation | - | > 2 · upper limit value |
| • | Time consta | ant $\tau = C_R \cdot R_{ins}$ | < 50 s |

¹⁾ Test criteria must be met after exposure to damp heat for 21 days



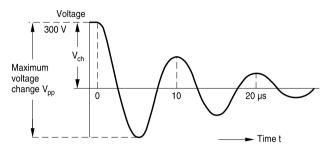
Ignition (stacked) SilverCap™



Pulse handling capability

The capacitors are especially manufactured and tested to suit their intended applications.

Typical permissible load:



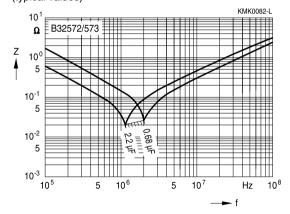
KMK0083-U-E

| Lead spacing | | 15 and 22.5 mm |
|--|--------------------------------|----------------|
| Max. rate of voltage rise V _{pp} /τ | (at $V_{pp} = 500 \text{ V}$) | 200 V/μs |
| Pulse characteristic k ₀ | (at V _{pp} ≤ 500 V) | 200 000 V²/μs |
| Max. charging voltage V _{ch} | (≤1 s) | 300 V DC |
| Max. voltage change V _{pp} | (at f = 100 kHz) | 500 V |

Unlimited number of pulses permitted.

Impedance Z versus frequency f

(typical values)







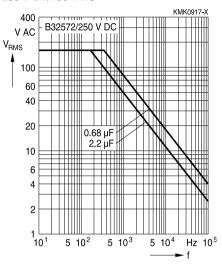
Ignition (stacked) SilverCap™

Permissible AC voltage V_{RMS} versus frequency f (for sinusoidal waveforms, $T_A \le 55$ °C)

For T_A >55 °C, please refer to "General technical information", section 3.2.3.

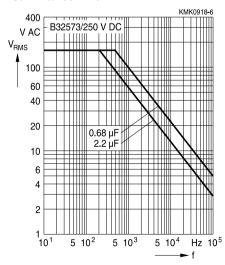
Lead spacing 15 mm

250 V DV/160 V AC



Lead spacing 22.5 mm

250 V DC/160 V AC





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Mounting guidelines

1 Soldering

1.1 Solderability of leads

The solderability of terminal leads is tested to IEC 60068-2-20, test Ta, method 1.

Before a solderability test is carried out, terminals are subjected to accelerated ageing (to IEC 60068-2-2, test Ba: 4 h exposure to dry heat at 155 °C). Since the ageing temperature is far higher than the upper category temperature of the capacitors, the terminal wires should be cut off from the capacitor before the ageing procedure to prevent the solderability being impaired by the products of any capacitor decomposition that might occur.

| Solder bath temperature | 235 ±5 °C |
|-------------------------|---|
| Soldering time | 2.0 ±0.5 s |
| Immersion depth | 2.0 +0/-0.5 mm from capacitor body or seating plane |
| Evaluation criteria: | |
| Visual inspection | Wetting of wire surface by new solder ≥90%, free-flowing solder |

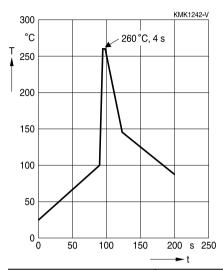
1.2 Resistance to soldering heat

Resistance to soldering heat is tested to IEC 60068-2-20, test Tb, method 1A. Conditions:

| Series | S | Solder bath temperature | Soldering time |
|--------|---|-------------------------|----------------------------|
| MKT | boxed (except 2.5 \times 6.5 \times 7.2 mm) | 260 ±5 °C | 10 ±1 s |
| | coated | | |
| | uncoated (lead spacing > 10 mm) | | |
| MFP | | | |
| MKP | (lead spacing > 7.5 mm) | | |
| MKT | boxed (case $2.5 \times 6.5 \times 7.2$ mm) | | 5 ±1 s |
| MKP | (lead spacing ≤ 7.5 mm) | | < 4 s |
| MKT | uncoated (lead spacing ≤ 10 mm) | | recommended soldering |
| | insulated (B32559) | | profile for MKT uncoated |
| | | | (lead spacing ≤ 10 mm) and |
| | | | insulated (B32559) |







| Immersion depth | 2.0 + 0/-0.5 mm from capacitor body or seating plane | |
|----------------------|--|--|
| Shield | Heat-absorbing board, (1.5 \pm 0.5) mm thick, between capacitor body and liquid solder | |
| Evaluation criteria: | | |
| Visual inspection | No visible damage | |
| $\Delta C/C_0$ | 2% for MKT/MKP/MFP 5% for EMI suppression capacitors | |
| $tan \delta$ | As specified in sectional specification | |



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1.3 General notes on soldering

Permissible heat exposure loads on film capacitors are primarily characterized by the upper category temperature T_{max} . Long exposure to temperatures above this type-related temperature limit can lead to changes in the plastic dielectric and thus change irreversibly a capacitor's electrical characteristics. For short exposures (as in practical soldering processes) the heat load (and thus the possible effects on a capacitor) will also depend on other factors like:

- Pre-heating temperature and time
- Forced cooling immediately after soldering
- Terminal characteristics: diameter, length, thermal resistance, special configurations (e.g. crimping)
- Height of capacitor above solder bath
- Shadowing by neighboring components
- Additional heating due to heat dissipation by neighboring components
- Use of solder-resist coatings

The overheating associated with some of these factors can usually be reduced by suitable countermeasures. For example, if a pre-heating step cannot be avoided, an additional or reinforced cooling process may possibly have to be included.

EPCOS recommends the following conditions:

- Pre-heating with a maximum temperature of 110 °C
- Temperature inside the capacitor should not exceed the following limits:
 - MKP/MFP 110 °C
 - MKT 160 °C
- When SMD components are used together with leaded ones, the leaded film capacitors should not pass into the SMD adhesive curing oven. The leaded components should be assembled after the SMD curing step.
- Leaded film capacitors are not suitable for reflow soldering.

Uncoated capacitors

For uncoated MKT capacitors with lead spacings ≤10 mm (B32560/B32561) the following measures are recommended:

- pre-heating to not more than 110 °C in the preheater phase
- rapid cooling after soldering





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2 Cleaning

To determine whether the following solvents, often used to remove flux residues and other substances, are suitable for the capacitors described, refer to the table below:

| Туре | Ethanol, isopropanol, n-propanol | n-propanol-water mixtures, water with surface tension-reducing tensides (neutral) | Solvent from table A (see next page) | Solvent from table B (see next page) |
|---------------------------------|--|---|--|--|
| MKT (uncoated) | Suitable | Unsuitable | In part suitable | Unsuitable |
| MKT, MKP, MFP (coated/boxed) | | Suitable | Suitable | |

Even when suitable solvents are used, a reversible change of the electrical characteristics may occur in uncoated capacitors immediately after they are washed. Thus it is always recommended to dry the components (e.g. 4 h at 70 °C) before they are subjected to subsequent electrical testing.

Table A

Manufacturers' designations for trifluoro-trichloro-ethane-based cleaning solvents (selection)

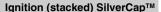
| Trifluoro-trichloro- ethane | Mixtures of trifluoro-trichloro-ethane with ethanol and isopropanol | Manufacturer |
|--------------------------------|---|--------------|
| Freon TF | Freon TE 35; Freon TP 35; Freon TES | Du Pont |
| Frigen 113 TR | Frigen 113 TR-E; Frigen 113 TR-P; Frigen TR-E 35 | Hoechst |
| Arklone P | Arklone A; Arklone L; Arklone K | ICI |
| Kaltron 113 MDR | Kaltron 113 MDA; Kaltron 113 MDI; Kaltron 113 MDI 35 | Kali-Chemie |
| Flugene 113 | Flugene 113 E; Flugene 113 IPA | Rhone-Progil |

Table B (worldwide banned substances)

Manufacturers' designations for unsuitable cleaning solvents (selection)

| Mixtures of chlorinated hydrocarbons and ketones with fluorated hydrocarbons | Manufacturer |
|--|--------------|
| Freon TMC; Freon TA; Freon TC | Du Pont |
| Arklone E | ICI |
| Kaltron 113 MDD; Kaltron 113 MDK | Kali-Chemie |
| Flugene 113 CM | Rhone-Progil |







3 Embedding of capacitors in finished assemblies

In many applications, finished circuit assemblies are embedded in plastic resins. In this case, both chemical and thermal influences of the embedding ("potting") and curing processes must be taken into account.

Our experience has shown that the following potting materials can be recommended: non-flexible epoxy resins with acid-anhydride hardeners; chemically inert, non-conducting fillers; maximum curing temperature of 100 $^{\circ}$ C.

Caution:

Consult us first if you wish to embed uncoated types!





Ignition (stacked) SilverCap™

Cautions and warnings

- Do not exceed the upper category temperature (UCT).
- Do not apply any mechanical stress to the capacitor terminals.
- Avoid any compressive, tensile or flexural stress.
- Do not move the capacitor after it has been soldered to the PC board.
- Do not pick up the PC board by the soldered capacitor.
- Do not place the capacitor on a PC board whose PTH hole spacing differs from the specified lead spacing.
- Do not exceed the specified time or temperature limits during soldering.
- Avoid external energy inputs, such as fire or electricity.
- Avoid overload of the capacitors.

The table below summarizes the safety instructions that must always be observed. A detailed description can be found in the relevant sections of the chapters "General technical information" and "Mounting guidelines".

| Topic | Safety information | Reference chapter "General technical information" |
|-------------------------|---|---|
| Storage conditions | Make sure that capacitors are stored within the specified range of time, temperature and humidity conditions. | 4.5 "Storage conditions" |
| Flammability | Avoid external energy, such as fire or electricity (passive flammability), avoid overload of the capacitors (active flammability) and consider the flammability of materials. | 5.3 "Flammability" |
| Resistance to vibration | esistance to Do not exceed the tested ability to withstand | |





| Topic | Safety information | Reference chapter "Mounting guidelines" |
|---|--|--|
| Soldering | Do not exceed the specified time or temperature limits during soldering. | 1 "Soldering" |
| Cleaning | Use only suitable solvents for cleaning capacitors. | 2 "Cleaning" |
| Embedding of capacitors in finished assemblies in plastic resins, chemical and thermal influences must be taken into account. Caution: Consult us first, if you also wish to embed other uncoated component types! | | 3 "Embedding of capacitors in finished assemblies" |





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Symbols and terms

| Symbol | English | German |
|---------------------|---|---|
| α | Heat transfer coefficient | Wärmeübergangszahl |
| α_{C} | Temperature coefficient of capacitance | Temperaturkoeffizient der Kapazität |
| Α | Capacitor surface area | Kondensatoroberfläche |
| $eta_{	extsf{C}}$ | Humidity coefficient of capacitance | Feuchtekoeffizient der Kapazität |
| С | Capacitance | Kapazität |
| C_R | Rated capacitance | Nennkapazität |
| ΔC | Absolute capacitance change | Absolute Kapazitätsänderung |
| Δ C/C | Relative capacitance change (relative | Relative Kapazitätsänderung (relative |
| | deviation of actual value) | Abweichung vom Ist-Wert) |
| $\Delta C/C_R$ | Capacitance tolerance (relative deviation | Kapazitätstoleranz (relative Abweichung |
| | from rated capacitance) | vom Nennwert) |
| dt | Time differential | Differentielle Zeit |
| Δt | Time interval | Zeitintervall |
| ΔT | Absolute temperature change | Absolute Temperaturänderung |
| | (self-heating) | (Selbsterwärmung) |
| $\Delta tan \delta$ | Absolute change of dissipation factor | Absolute Änderung des Verlustfaktors |
| ΔV | Absolute voltage change | Absolute Spannungsänderung |
| dV/dt | Time differential of voltage function (rate | Differentielle Spannungsänderung |
| | of voltage rise) | (Spannungsflankensteilheit) |
| $\Delta V/\Delta t$ | Voltage change per time interval | Spannungsänderung pro Zeitintervall |
| E | Activation energy for diffusion | Aktivierungsenergie zur Diffusion |
| ESL | Self-inductance | Eigeninduktivität |
| ESR | Equivalent series resistance | Ersatz-Serienwiderstand |
| f | Frequency | Frequenz |
| f ₁ | Frequency limit for reducing permissible | Grenzfrequenz für thermisch bedingte |
| | AC voltage due to thermal limits | Reduzierung der zulässigen |
| , | | Wechselspannung |
| f ₂ | Frequency limit for reducing permissible | Grenzfrequenz für strombedingte |
| | AC voltage due to current limit | Reduzierung der zulässigen Wechselspannung |
| 4 | Resonant frequency | Resonanzfrequenz |
| f _r | Thermal acceleration factor for diffusion | ' |
| F_D | Thermal acceleration factor for diffusion | Therm. Beschleunigungsfaktor zur Diffusion |
| F_T | Derating factor | Deratingfaktor |
| i | Current (peak) | Stromspitze |
| Ic | Category current (max. continuous current) | Kategoriestrom (max. Dauerstrom) |





| Symbol | English | German |
|--|--|---|
| I _{RMS} | (Sinusoidal) alternating current, | (Sinusförmiger) Wechselstrom |
| | root-mean-square value | International des Konnec't #4 |
| i _z | Capacitance drift | Inkonstanz der Kapazität |
| k ₀ | Pulse characteristic | Impulskennwert |
| L _s | Series inductance | Serieninduktivität |
| λ | Failure rate | Ausfallrate |
| λο | Constant failure rate during useful service life | Konstante Ausfallrate in der Nutzungsphase |
| λ_{test} | Failure rate, determined by tests | Experimentell ermittelte Ausfallrate |
| P _{diss} | Dissipated power | Abgegebene Verlustleistung |
| P _{gen} | Generated power | Erzeugte Verlustleistung |
| Q gen | Heat energy | Wärmeenergie |
| | Density of water vapor in air | Dichte von Wasserdampf in Luft |
| ρ R | Universal molar constant for gases | Allg. Molarkonstante für Gas |
| R | • | Ohmscher Widerstand des |
| n | Ohmic resistance of discharge circuit | Entladekreises |
| R_i | Internal resistance | Innenwiderstand |
| R _{ins} | Insulation resistance | Isolationswiderstand |
| R _P | Parallel resistance | Parallelwiderstand |
| Rs | Series resistance | Serienwiderstand |
| S | severity (humidity test) | Schärfegrad (Feuchtetest) |
| t | Time | Zeit |
| Т | Temperature | Temperatur |
| τ | Time constant | Zeitkonstante |
| tan δ | Dissipation factor | Verlustfaktor |
| $tan \; \delta_{\scriptscriptstyle D}$ | Dielectric component of dissipation factor | Dielektrischer Anteil des Verlustfaktors |
| tan δ _P | Parallel component of dissipation factor | Parallelanteil des Verlfustfaktors |
| $\tan \delta_s$ | Series component of dissipation factor | Serienanteil des Verlustfaktors |
| T _A | Ambient temperature | Umgebungstemperatur |
| T _{max} | Upper category temperature | Obere Kategorietemperatur |
| T _{min} | Lower category temperature | Untere Kategorietemperatur |
| t _{OL} | Operating life at operating temperature | Betriebszeit bei Betriebstemperatur und |
| OL. | and voltage | -spannung |
| T _{op} | Operating temperature | Beriebstemperatur |
| T _B | Rated temperature | Nenntemperatur |
| T _{ref} | Reference temperature | Referenztemperatur |
| t _{SL} | Reference service life | Referenz-Lebensdauer |
| V_{AC} | AC voltage | Wechselspannung |





| Symbol | English | German |
|-----------------------|-----------------------------------|---------------------------------------|
| V _C | Category voltage | Kategoriespannung |
| $V_{C,RMS}$ | Category AC voltage | (Sinusförmige) |
| | | Kategorie-Wechselspannung |
| V_{CD} | Corona-discharge onset voltage | Teilentlade-Einsatzspannung |
| V_{ch} | Charging voltage | Ladespannung |
| V_{DC} | DC voltage | Gleichspannung |
| V_{FB} | Fly-back capacitor voltage | Spannung (Flyback) |
| V_{i} | Input voltage | Eingangsspannung |
| V_{o} | Output voltage | Ausgangssspannung |
| V_{op} | Operating voltage | Betriebsspannung |
| V_p | Peak pulse voltage | Impuls-Spitzenspannung |
| V_{pp} | Peak-to-peak voltage Impedance | Spannungshub |
| V_R | Rated voltage | Nennspannung |
| v _R | Amplitude of rated AC voltage | Amplitude der Nenn-Wechselspannung |
| V_{RMS} | (Sinusoidal) alternating voltage, | (Sinusförmige) Wechselspannung |
| | root-mean-square value | |
| V_{SC} | S-correction voltage | Spannung bei Anwendung "S-correction" |
| V_{sn} | Snubber capacitor voltage | Spannung bei Anwendung |
| | | "Beschaltung" |
| Z | Impedance | Scheinwiderstand |
| е | Lead spacing | Rastermaß |



Important notes

The following applies to all products named in this publication:

- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule, EPCOS is either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an EPCOS product with the properties described in the product specification is suitable for use in a particular customer application.
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